

N-Channel SiC Power MOSFET

Features

- High Blocking Voltage with Low On-Resistance
- High Speed Switching with Low Capacitance
- Easy to connect in parallel and to Drive

Benefits

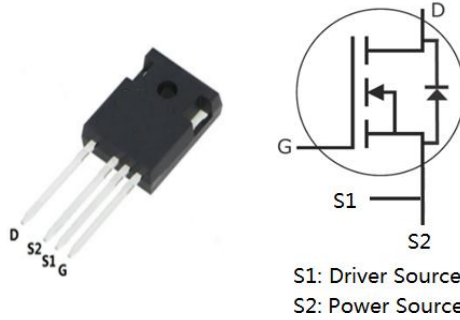
- Higher System Efficiency
- Reduced Cooling Requirements
- Increased Power Density
- Increased System Switching Frequency

Applications

- High Voltage DC/DC Converters
- Motor Drives
- Switch Mode Power Supplies
- Pulsed Power applications

V_{DS}	1200 V
R_{DS(on)}	40 mΩ
I_{D@25°C}	60 A

Package



Part Number	Package	Marking
RSM60N120T7L	TO-247-4	60N120

Maximum Ratings (T_c=25°C unless otherwise specified)

Symbol	Parameter	Value	Unit	Test Conditions	Note
V _{DSmax}	Drain-Source Voltage	1200	V	V _{GS} =0V, I _D =100μA	
V _{GSmax}	Gate-Source Voltage	-10/+25	V	Absolute maximum values	
V _{GSop}	Gate-Source Voltage	-5/+20	V	Recommended operational values	
I _D	Continuous Drain Current	60	A	V _{GS} =20V, T _c =25°C	
		40		V _{GS} =20V, T _c =100°C	
I _{D(pulse)}	Pulsed Drain Current	160	A	Pulse width t _p limited by T _{Jmax}	
P _D	Power Dissipation	330	W	T _c =25°C, T _J =150°C	
T _J , T _{STG}	Operating Junction and Storage Temperature	-55 to +175	°C		

Electrical Characteristics (T_C=25°C unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Unit	Test Conditions	Note
V _{(BR)DSS}	Drain-Source Breakdown Voltage	1200			V	V _{GS} =0V, I _D =100μA	
V _{GS(th)}	Gate Threshold Voltage	1.9	2.5	4.0	V	V _{DS} =V _{GS} , I _D =10mA	
			1.8			V _{DS} =V _{GS} , I _D =10mA, T _J =150°C	
I _{DSS}	Zero Gate Voltage Drain Current		1	100	μA	V _{DS} =1200V, V _{GS} =0V	
I _{GSS+}	Gate-Source Leakage Current		10	250	nA	V _{DS} =0V, V _{GS} =25V	
I _{GSS-}	Gate-Source Leakage Current		10	250	nA	V _{DS} =0V, V _{GS} =-10V	
R _{DS(on)}	Drain-Source On-State Resistance		40	55	mΩ	V _{GS} =20V, I _D =40A	
			80			V _{GS} =20V, I _D =40A, T _J =150°C	
C _{iss}	Input Capacitance		2946		pF	V _{GS} =0V	
C _{oss}	Output Capacitance		167			V _{DS} =1000V	
C _{rss}	Reverse Transfer Capacitance		6.6			f=1MHz	
E _{oss}	C _{oss} Stored Energy		92			V _{AC} =25mV	
E _{ON}	Turn-On Switching Energy		1.1		mJ	V _{DS} =800V, V _{GS} =-5V/20V	
E _{OFF}	Turn-Off Switching Energy		0.85			I _D =40A, R _{G(ext)} =2.5Ω, L=100μH	
t _{d(on)}	Turn-On Delay Time		12		ns	V _{DS} =800V, V _{GS} =-5V/20V, I _D =40A R _{G(ext)} =2.5Ω, R _L =20Ω	
t _r	Rise Time		10				
t _{d(off)}	Turn-Off Delay Time		25				
t _f	Fall Time		6.2				
R _{G(int)}	Internal Gate Resistance		2.3		Ω	f=1MHz, V _{AC} =25mV	
Q _{GS}	Gate to Source Charge		37		nC	V _{DS} =800V	
Q _{GD}	Gate to Drain Charge		18			V _{GS} =-5V/20V	
Q _G	Total Gate Charge		142			I _D =40A	

Reverse Diode Characteristics

Symbol	Parameter	Typ.	Max.	Unit	Test Conditions	Note
V _{SD}	Diode Forward Voltage	4.5		V	V _{GS} =-5V, I _{SD} =20A	
		4.2			V _{GS} =-5V, I _{SD} =20A, T _J =150°C	
I _S	Continuous Diode Forward Current		TBD	A	T _C =25°C	
t _{rr}	Reverse Recover Time	41		ns	V _R =800V, I _{SD} =40A	
Q _{rr}	Reverse Recovery Charge	142		nC		
I _{rrm}	Peak Reverse Recovery Current	6		A		

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit	Test Conditions	Note
R _{θJC}	Thermal Resistance from Junction to Case	0.34		°C/W		
R _{θJA}	Thermal Resistance from Junction to Ambient		40			

RATING AND CHARACTERISTICS CURVES (RSM60N120T7L)

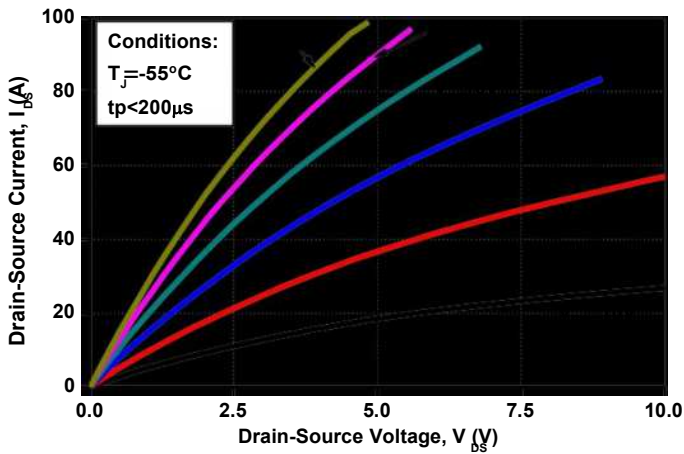


Figure 1. Output Characteristics $T_J = -55^\circ\text{C}$

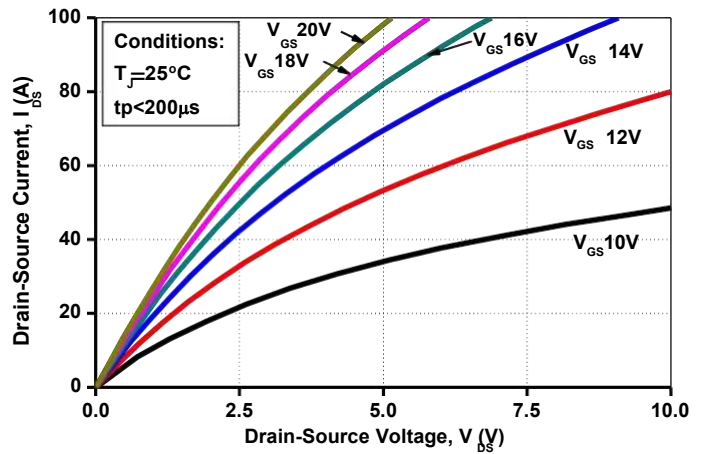


Figure 2. Output Characteristics $T_J = 25^\circ\text{C}$

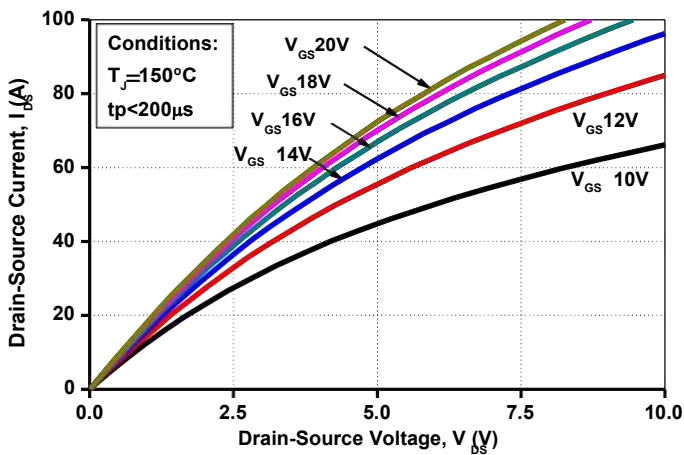


Figure 3. Output Characteristics $T_J = 150^\circ\text{C}$

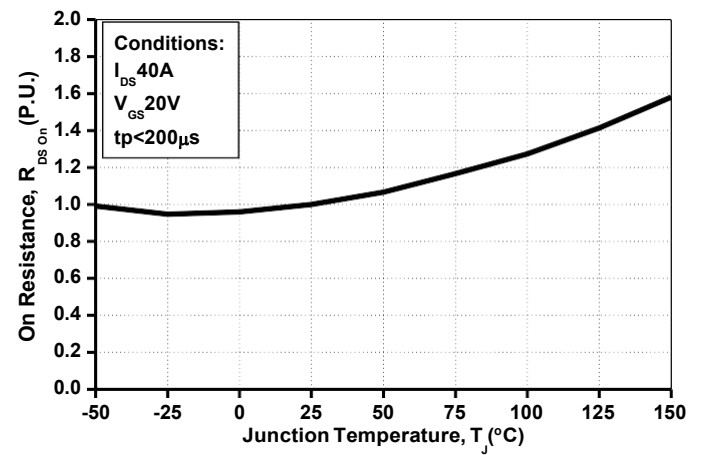


Figure 4. Normalized On-Resistance vs. Temperature

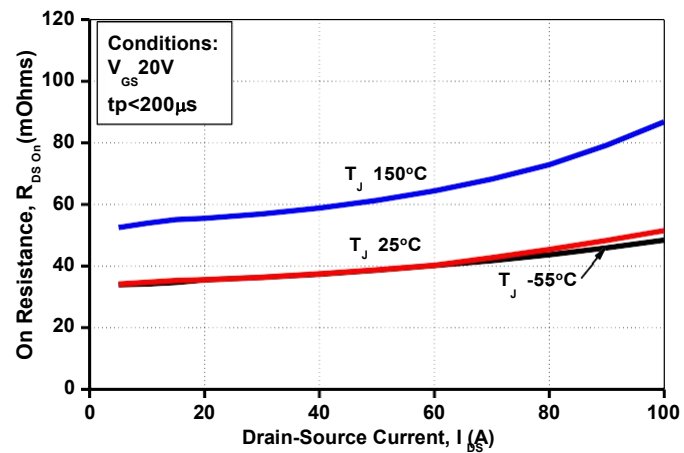


Figure 5. On-Resistance vs. Drain Current For Various Temperatures

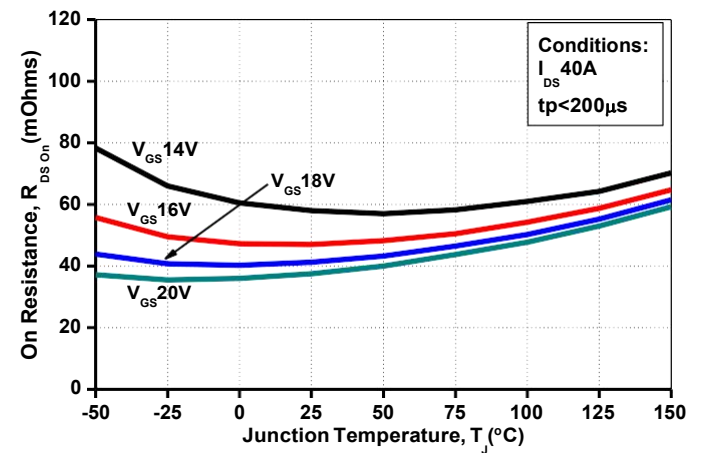


Figure 6. On-Resistance vs. Temperature For Various Gate Voltage

RATING AND CHARACTERISTICS CURVES (RSM60N120T7L)

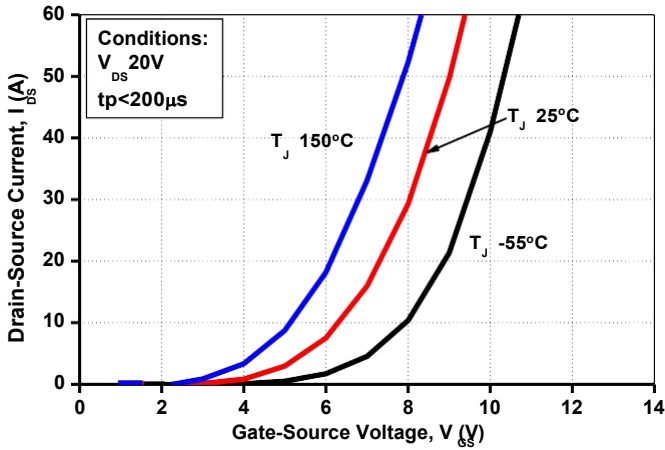


Figure 7. Transfer Characteristic for Various Junction Temperatures

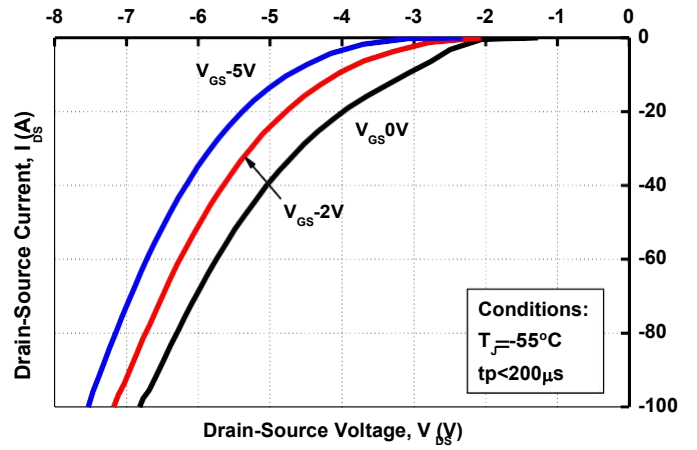


Figure 8. Body Diode Characteristic at -55 °C

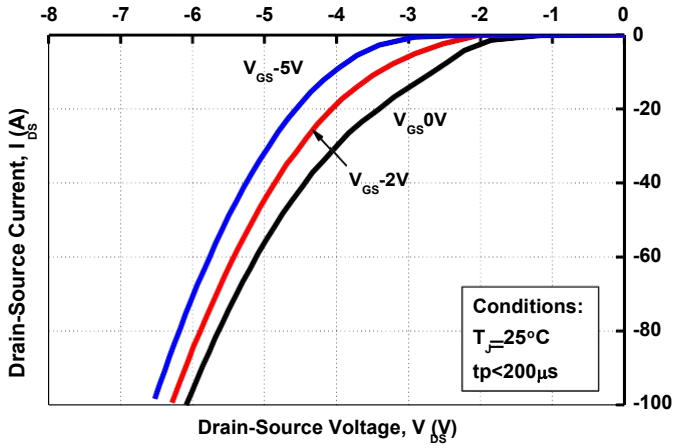


Figure 9. Body Diode Characteristic at 25 °C

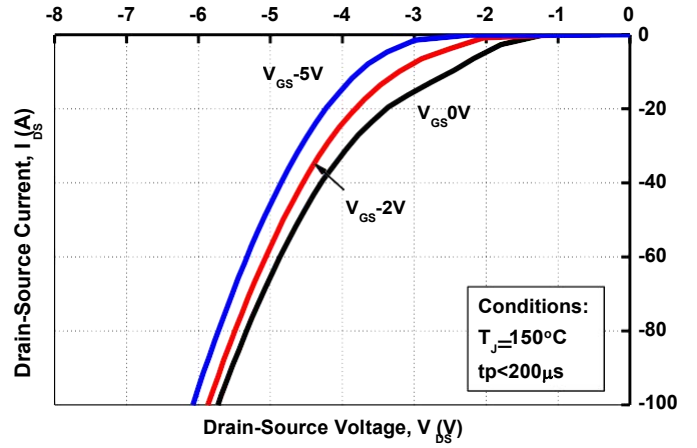


Figure 10. Body Diode Characteristic at 150 °C

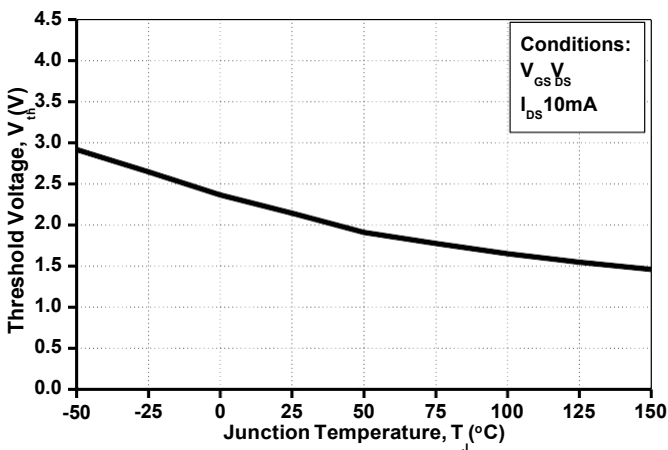


Figure 11. Threshold Voltage vs. Temperature

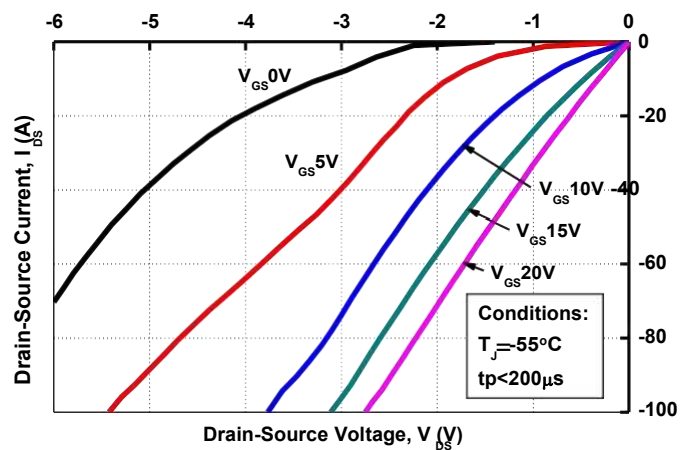


Figure 12. 3rd Quadrant Characteristic at -55 °C

RATING AND CHARACTERISTICS CURVES (RSM60N120T7L)

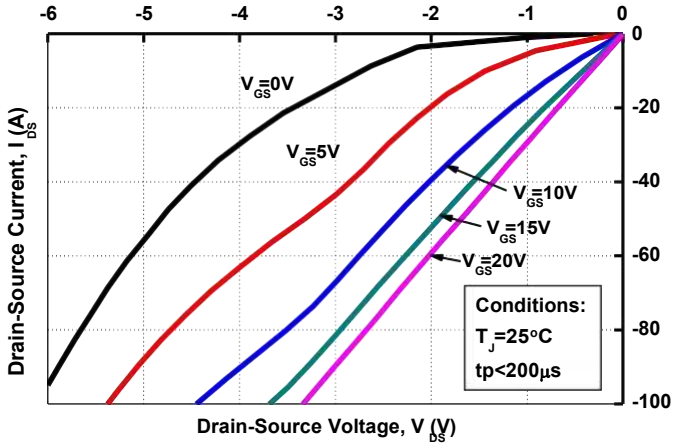


Figure 13. 3rd Quadrant Characteristic at 25 °C

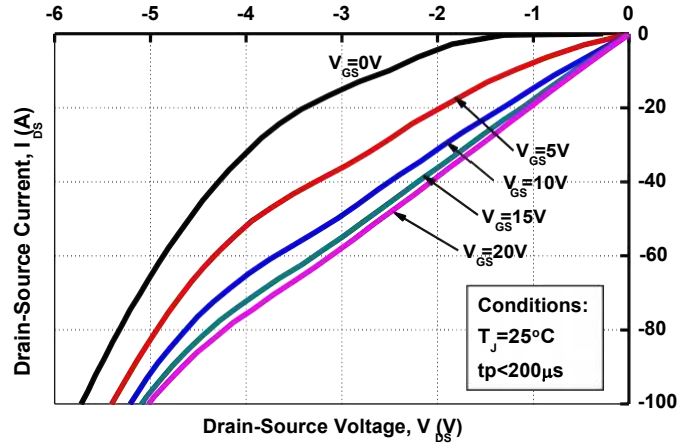


Figure 14. 3rd Quadrant Characteristic at 150 °C

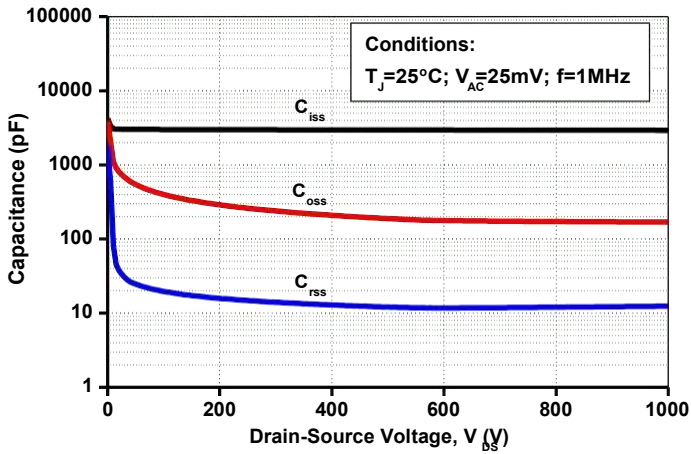


Figure 15. Capacitances vs. Drain-Source Voltage (0 - 200V)

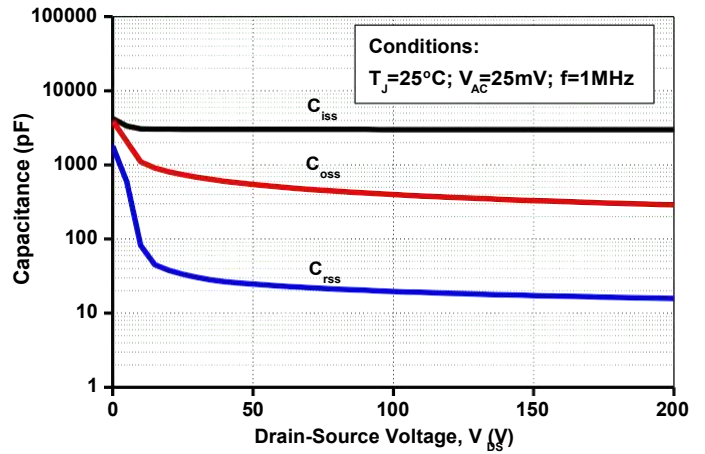
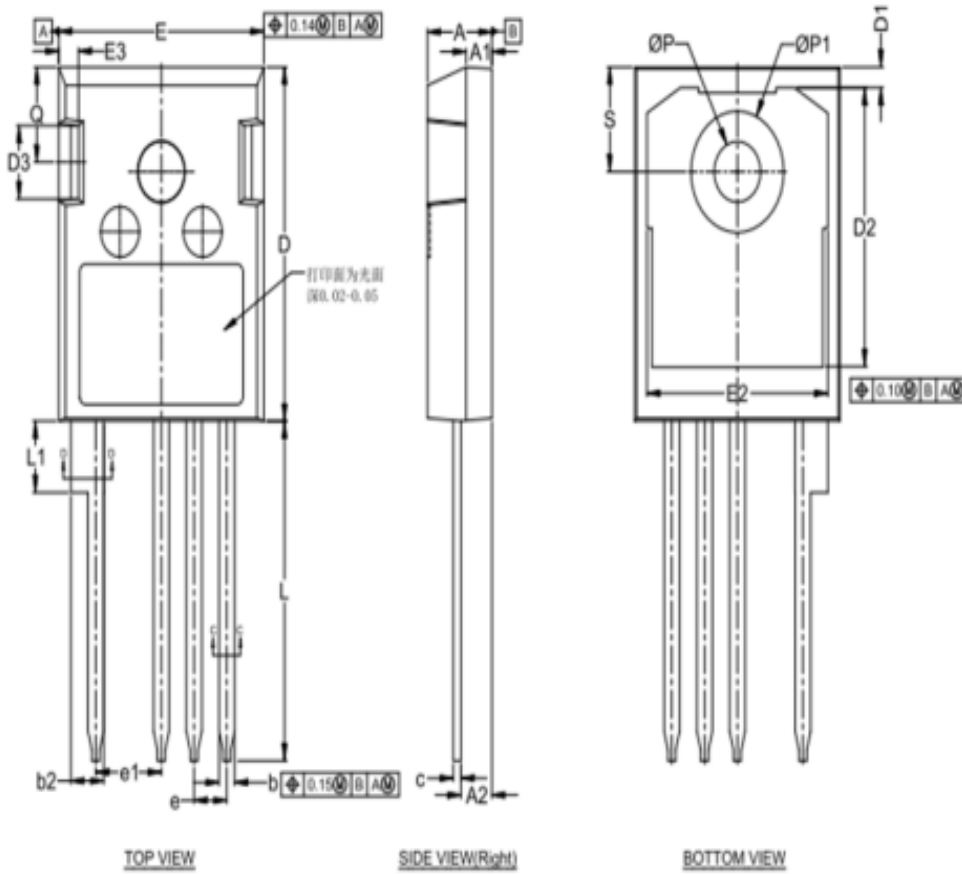


Figure 16. Capacitances vs. Drain-Source Voltage (0 - 1000V)

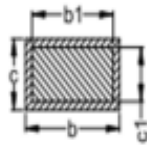
TO-247-4 Package



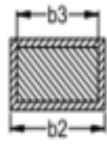
DIM SYMBOL	MIN.	NOM.	MAX.
A	4.900	5.000	5.100
A1	1.940	2.040	2.140
A2	2.300	2.400	2.500
b	1.140	1.240	1.330
b1	1.100	1.200	1.300
b2	2.490	2.590	2.690
b3	2.450	2.550	2.650
c	0.550	0.640	0.700
c1	0.500	0.600	0.700
D	20.850	20.950	21.050
D1	1.022	1.222	1.400
D2	16.348	16.548	16.748
D3	4.232	4.332	4.432
E	15.800	15.900	16.000
E2	13.821	14.021	14.221
E3	1.430	1.530	1.630
e	2.540 BSC.		
e1	5.080 BSC.		
L	19.900	20.100	20.300
L1	4.024	4.224	4.424
ØP	3.500	3.600	3.700
ØP1	7.088	7.188	7.288
Q	5.435	5.635	5.835
S	6.040	6.200	6.300



SIDE VIEW(Front)



SECTION C-C



SECTION D-D

DISCLAIMER NOTICE

Rectron Inc reserves the right to make changes without notice to any product specification herein, to make corrections, modifications, enhancements or other changes. Rectron Inc or anyone on its behalf assumes no responsibility or liability for any errors or inaccuracies. Data sheet specifications and its information contained are intended to provide a product description only. "Typical" parameters which may be included on RECTRON data sheets and/ or specifications can and do vary in different applications and actual performance may vary over time. Rectron Inc does not assume any liability arising out of the application or use of any product or circuit.

Rectron products are not designed, intended or authorized for use in medical, life-saving implant or other applications intended for life-sustaining or other related applications where a failure or malfunction of component or circuitry may directly or indirectly cause injury or threaten a life without expressed written approval of Rectron Inc. Customers using or selling Rectron components for use in such applications do so at their own risk and shall agree to fully indemnify Rectron Inc and its subsidiaries harmless against all claims, damages and expenditures.